

Vishay General Semiconductor

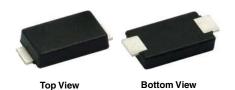
Rohs

HALOGEN

FREE

Surface Mount ESD Capability Rectifiers

SlimSMA



DO-221AC

PRIMARY CHARACTERISTICS						
I _{F(AV)} 2.0 A						
V _{RRM}	100 V to 600 V					
I _{FSM}	35 A					
V_F at $I_F = 2.0$ A $(T_A = 125 ^{\circ}C)$	0.86 V					
I _R	5 μΑ					
T _J max.	175 °C					

TYPICAL APPLICATIONS

General purpose, power line polarity protection, in both consumer and automotive applications.

FEATURES

- Very low profile typical height of 0.95 mm
- · Ideal for automated placement
- Oxide planar chip junction
- Low forward voltage drop, low leakage current
- ESD capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified
- Material categorization: For definitions of compliance please see <u>www.vishav.com/doc?99912</u>

MECHANICAL DATA

Case: DO-221AC (SlimSMA)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 1A whisker test, HM3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes the cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	SE20AFB	SE20AFD	SE20AFG	SE20AFJ	UNIT
Device marking code		20B	20D	20G	20J	
Maximum repetitive peak reverse voltage	V_{RRM}	100	200	400	600	V
Maximum DC forward current	I _F ⁽¹⁾	2.0				А
Waximum bo forward current	I _F ⁽²⁾	1.3				
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	35			Α	
Operating junction and storage temperature range	T _J , T _{STG}	- 55 to + 175			°C	

Notes

- (1) Mounted on 5.0 mm x 5.0 mm pad areas, 2 oz. FR4 PCB
- (2) Free air, mounted on recommended copper pad area

SE20AFB thru SE20AFJ

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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 1.0 A	T _A = 25 °C		0.91	-	V
	I _F = 2.0 A		V _E (1)	0.96	1.1	
	I _F = 1.0 A	- T _A = 125 °C	V _F (·)	0.79	-	
	I _F = 2.0 A			0.86	0.98	
Reverse current	Rated V _R	T _A = 25 °C	I _R ⁽²⁾	-	5.0	
	nated V _R	T _A = 125 °C	T IR (-)	8	100	μΑ
Typical reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$		t _{rr}	1.2	-	μs
Typical junction capacitance	4.0 V, 1 MHz		CJ	12	-	pF

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T _A = 25 °c unless otherwise noted)						
PARAMETER SYMBOL SE20AFB SE20AFG SE20AFJ UN					UNIT	
Typical thermal resistance		125			°C/W	
Typical thermal resistance	R _{0JM} (2)	12				C/VV

Notes

 $^{(1)}$ Free air, mounted on recommended PCB, 1 oz. pad area; thermal resistance $R_{\theta JA}$ - junction to ambient

Mounted on 5.0 mm x 5.0 mm pad areas, 2 oz. FR4 PCB; $R_{\theta JM}$ - junction to mount

IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS (T _A = 25 $^{\circ}$ C unless otherwise noted)							
STANDARD	STANDARD TEST TYPE TEST CONDITIONS SYMBOL CLASS VALUE						
AEC-Q101-001	Human body model (contact mode)	$C = 100 \text{ pF}, R = 1.5 \text{ k}\Omega$	V _C	НЗВ	> 8 kV		

ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
SE20AFJ-M3/6A	0.032	6A	3500	7" diameter plastic tape and reel		
SE20AFJ-M3/6B	0.032	6B	14 000	13" diameter plastic tape and reel		
SE20AFJHM3/6A (1)	0.032	6A	3500	7" diameter plastic tape and reel		
SE20AFJHM3/6B (1)	0.032	6B	14 000	13" diameter plastic tape and reel		

Note

(1) AEC-Q101 qualified

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RATINGS AND CHARACTERISTICS CURVES

(T_A = 25 °C unless otherwise noted)

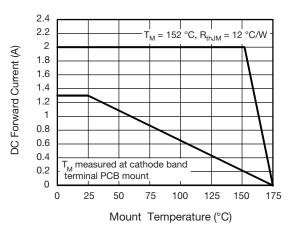


Fig. 1 - Maximum Forward Current Derating Curve

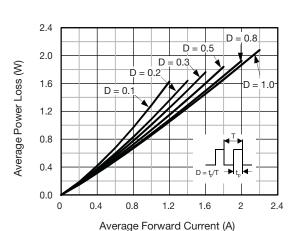


Fig. 2 - Forward Power Loss Characteristics

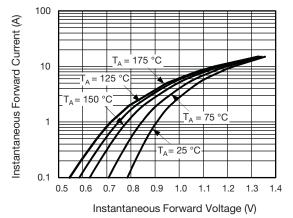
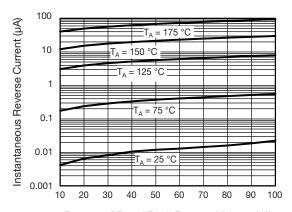


Fig. 3 - Typical Instantaneous Forward Characteristics



Percent of Rated Peak Reverse Voltage (%)

Fig. 4 - Typical Reverse Leakage Characteristics

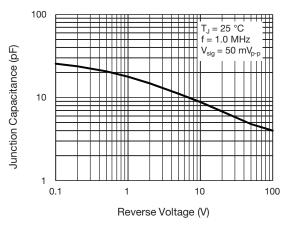


Fig. 5 - Typical Junction Capacitance

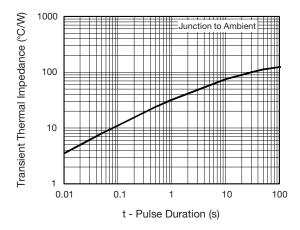


Fig. 6 - Typical Junction Capacitance

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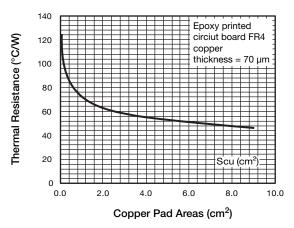
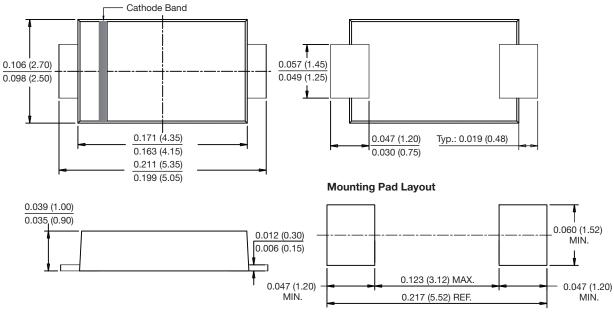


Fig. 7 - Thermal Resistance Junction to Ambient vs. Copper Pad Areas

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

DO-221AC (SlimSMA)





Legal Disclaimer Notice

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